

U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

## PATENT WITHDRAWAL NOTICE

DATE WITHDRAWN	WITHDRAWAL NUMBER
7/16/07	15625
The following application has been <b>WITHDRAWN</b> from the <b><u>Tuesday, July 24, 2007</u></b> issue.	
SERIAL NO.	PATENT NUMBER
10/706,902	7,247,253
DRAWINGS	CLASS
0	216/066
TITLE	
SELECTIVE ETCH PROCESS OF A SACRIFICIAL LIGHT ABSORBING MATERIAL (SLAM) OVER A DIELECTRIC MATERIAL	
NAME AND ADDRESS	
HEE YEOP CHAE, ET AL SAN JOSE, CA	
REASON FOR WITHDRAWAL	
Office of Petitions granted applicant's request to withdraw patent from issue.	
APPROVED	
<u>/ Mary Louise McAskill, Manager /</u> Statistical Analysis Division	